OCTAL BUS TRANSCEIVER

SN74LVCR2245A

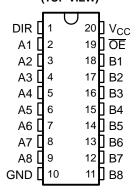
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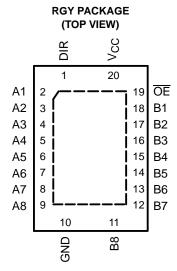
#### **FEATURES**

- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t<sub>pd</sub> of 6.3 ns at 3.3 V
- All Outputs Have Equivalent 26- $\Omega$  Series Resistors, So No External Resistors Are Required
- Typical V<sub>OLP</sub> (Output Ground Bounce)
   <0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)
   >2 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C

DB, DBQ, DGV, DW, NS, OR PW PACKAGE (TOP VIEW)



- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V<sub>CC</sub>)
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 1000-V Charged-Device Model (C101)



#### DESCRIPTION/ORDERING INFORMATION

#### ORDERING INFORMATION

| T <sub>A</sub> | PACKAGE               | (1)          | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-----------------------|--------------|-----------------------|------------------|
|                | QFN – RGY             | Reel of 1000 | SN74LVCR2245ARGYR     | LER245A          |
|                | SOIC - DW             | Tube of 25   | SN74LVCR2245ADW       | LVCR2245A        |
|                | SOIC - DW             | Reel of 2000 | SN74LVCR2245ADWR      | LVCR2245A        |
|                | SOP - NS              | Reel of 2000 | SN74LVCR2245ANSR      | LVCR2245A        |
|                | SSOP - DB             | Reel of 2000 | SN74LVCR2245ADBR      | LER245A          |
| –40°C to 85°C  | SSOP (QSOP) – DBQ     | Reel of 2500 | SN74LVCR2245ADBQR     | LVCR2245A        |
| -40°C 10 85°C  |                       | Tube of 70   | SN74LVCR2245APW       |                  |
|                | TSSOP - PW            | Reel of 2000 | SN74LVCR2245APWR      | LER245A          |
|                |                       | Reel of 250  | SN74LVCR2245APWT      |                  |
|                | TVSOP - DGV           | Reel of 2000 | SN74LVCR2245ADGVR     | LER245A          |
|                | VFBGA – GQN           | Reel of 1000 | SN74LVCR2245AGQNR     | 1 ED0454         |
|                | VFBGA – ZQN (Pb-free) | Reel of 1000 | SN74LVCR2245AZQNR     | LER245A          |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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## **DESCRIPTION/ORDERING INFORMATION (CONTINUED)**

This octal bus transceiver is designed for 1.65-V to 3.6-V  $V_{CC}$  operation.

The SN74LVCR2245A is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (OE) input can be used to disable the device so the buses are effectively isolated.

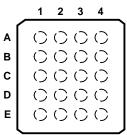
All outputs, which are designed to sink up to 12 mA, include equivalent 26- $\Omega$  resistors to reduce overshoot and undershoot.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

This device is fully specified for partial-power-down applications using  $I_{\text{off}}$ . The  $I_{\text{off}}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

# GQN OR ZQN PACKAGE (TOP VIEW)



## **TERMINAL ASSIGNMENTS**

|   | 1   | 2   | 3               | 4  |
|---|-----|-----|-----------------|----|
| Α | A1  | DIR | V <sub>CC</sub> | ŌĒ |
| В | А3  | B2  | A2              | B1 |
| С | A5  | A4  | B4              | В3 |
| D | A7  | В6  | A6              | B5 |
| Е | GND | A8  | B8              | B7 |

#### **FUNCTION TABLE**

| INP | UTS | OPERATION       |
|-----|-----|-----------------|
| OE  | DIR | OPERATION       |
| L   | L   | B data to A bus |
| L   | Н   | A data to B bus |
| Н   | Χ   | Isolation       |

SN74LVCR2245A

18 — B1



# R 1 19 OE

**LOGIC DIAGRAM (POSITIVE LOGIC)** 

To Seven Other Channels

Pin numbers shown are for the DB, DBQ, DGV, DW, NS, PW, and RGY packages.

## Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

|                  |   |                                     | MIN  | MAX                   | UNIT |
|------------------|---|-------------------------------------|------|-----------------------|------|
| V <sub>CC</sub>  | Supply voltage range                              |                                     | -0.5 | 6.5                   | V    |
| VI               | Input voltage range <sup>(2)</sup>                |                                     | -0.5 | 6.5                   | V    |
| Vo               | Voltage range applied to any output in the        | -0.5                                | 6.5  | V                     |      |
| Vo               | Voltage range applied to any output in the        | high or low state <sup>(2)(3)</sup> | -0.5 | V <sub>CC</sub> + 0.5 | V    |
| I <sub>IK</sub>  | Input clamp current                               | V <sub>1</sub> < 0                  |      | -50                   | mA   |
| I <sub>OK</sub>  | Output clamp current                              | V <sub>O</sub> < 0                  |      | -50                   | mA   |
| Io               | Continuous output current                         | Continuous output current           |      |                       |      |
|                  | Continuous current through V <sub>CC</sub> or GND |                                     |      | ±100                  | mA   |
|                  |   | DB package <sup>(4)</sup>           |      | 70                    |      |
|                  |   | DBQ package <sup>(4)</sup>          |      | 68                    |      |
|                  |   | DGV package <sup>(4)</sup>          |      | 92                    |      |
| 0                | Declare the areal in a decay                      | DW package <sup>(4)</sup>           |      | 58                    | 0000 |
| $\theta_{JA}$    | Package thermal impedance                         | GQN/ZQN package <sup>(4)</sup>      |      | 78                    | °C/W |
|                  |   | NS package <sup>(4)</sup>           |      | 60                    |      |
|                  |   | PW package <sup>(4)</sup>           |      | 83                    |      |
|                  |   | RGY package <sup>(5)</sup>          |      | 37                    |      |
| T <sub>stg</sub> | Storage temperature range                         |                                     | -65  | 150                   | °C   |

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>(2)</sup> The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>(3)</sup> The value of V<sub>CC</sub> is provided in the recommended operating conditions table.

<sup>(4)</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

<sup>(5)</sup> The package thermal impedance is calculated in accordance with JESD 51-5.

## SN74LVCR2245A OCTAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS





# Recommended Operating Conditions<sup>(1)</sup>

|                 |                                    |                                    | MIN                  | MAX                  | UNIT  |  |  |  |  |  |
|-----------------|------------------------------------|------------------------------------|----------------------|----------------------|-------|--|--|--|--|--|
| V               | Cumply voltage                     | Operating                          | 1.65                 | 3.6                  | V     |  |  |  |  |  |
| $V_{CC}$        | Supply voltage                     | Data retention only                | 1.5                  |                      | V     |  |  |  |  |  |
|                 |                                    | V <sub>CC</sub> = 1.65 V to 1.95 V | $0.65 \times V_{CC}$ |                      |       |  |  |  |  |  |
| $V_{IH}$        | High-level input voltage           | V <sub>CC</sub> = 2.3 V to 2.7 V   | 1.7                  |                      | V     |  |  |  |  |  |
|                 |                                    | V <sub>CC</sub> = 2.7 V to 3.6 V   | 2                    |                      |       |  |  |  |  |  |
|                 |                                    | V <sub>CC</sub> = 1.65 V to 1.95 V |                      | $0.35 \times V_{CC}$ |       |  |  |  |  |  |
| $V_{IL}$        | Low-level input voltage            | V <sub>CC</sub> = 2.3 V to 2.7 V   |                      | 0.7                  | 0.7 V |  |  |  |  |  |
|                 |                                    | V <sub>CC</sub> = 2.7 V to 3.6 V   |                      | 0.8                  |       |  |  |  |  |  |
| VI              | Input voltage                      |                                    | 0                    | 5.5                  | V     |  |  |  |  |  |
| V               | Output valtage                     | High or low state                  | 0                    | V <sub>CC</sub>      | V     |  |  |  |  |  |
| V <sub>O</sub>  | Output voltage                     | 3-state                            | 0                    | 5.5                  | v     |  |  |  |  |  |
|                 |                                    | V <sub>CC</sub> = 1.65 V           |                      | -2                   |       |  |  |  |  |  |
|                 | High lovel output outropt          | $V_{CC} = 2.3 \text{ V}$           |                      | -4                   | mA    |  |  |  |  |  |
| I <sub>OH</sub> | High-level output current          | $V_{CC} = 2.7 \text{ V}$           |                      | 8                    | IIIA  |  |  |  |  |  |
|                 |                                    | V <sub>CC</sub> = 3 V              |                      | -12                  |       |  |  |  |  |  |
|                 |                                    | V <sub>CC</sub> = 1.65 V           |                      | 2                    |       |  |  |  |  |  |
|                 | Low lovel output ourrent           | $V_{CC} = 2.3 \text{ V}$           |                      | 4                    | mΛ    |  |  |  |  |  |
| l <sub>OL</sub> | Low-level output current           | $V_{CC} = 2.7 \text{ V}$           |                      | 8                    | mA    |  |  |  |  |  |
|                 |                                    | V <sub>CC</sub> = 3 V              |                      | 12                   |       |  |  |  |  |  |
| Δt/Δν           | Input transition rise or fall rate |                                    |                      | 10                   | ns/V  |  |  |  |  |  |
| T <sub>A</sub>  | Operating free-air temperature     |                                    | -40                  | 85                   | °C    |  |  |  |  |  |

<sup>(1)</sup> All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



## SN74LVCR2245A **OCTAL BUS TRANSCEIVER** WITH 3-STATE OUTPUTS

### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

| PA                             | RAMETER        | TEST CONDITION  | IS                            | V <sub>cc</sub> | MIN            | TYP <sup>(1)</sup> | MAX | UNIT |  |
|--------------------------------|----------------|---|-------------------------------|-----------------|----------------|--------------------|-----|------|--|
|                                |                | $I_{OH} = -100 \mu A$   |                               | 1.65 V to 3.6 V | $V_{CC} - 0.2$ |                    |     |      |  |
|                                |                | $I_{OH} = -2 \text{ mA}$  |                               | 1.65 V          | 1.2            |                    |     |      |  |
|                                |                | 1 4 m A   |                               | 2.3 V           | 1.7            |                    |     |      |  |
| $V_{OH}$                       | $V_{OH}$       | $I_{OH} = -4 \text{ mA}$  | 2.7 V                         | 2.2             |                |                    | V   |      |  |
|                                |                | $I_{OH} = -6 \text{ mA}$  | 3 V                           | 2.4             |                |                    |     |      |  |
|                                |                | $I_{OH} = -8 \text{ mA}$  |                               | 2.7 V           | 2              |                    |     |      |  |
|                                |                | I <sub>OH</sub> = -12 mA  |                               | 3 V             | 2              |                    |     |      |  |
|                                |                | I <sub>OL</sub> = 100 μA  |                               | 1.65 V to 3.6 V |                |                    | 0.2 |      |  |
|                                |                | I <sub>OL</sub> = 2 mA  | 1.65 V                        |                 |                | 0.45               |     |      |  |
|                                |                | 1 4 50 0  |                               | 2.3 V           |                |                    | 0.7 |      |  |
| $V_{OL}$                       |                | I <sub>OL</sub> = 4 mA  | 2.7 V                         |                 |                | 0.4                | V   |      |  |
|                                |                | I <sub>OL</sub> = 6 mA  | 3 V                           |                 |                | 0.55               |     |      |  |
|                                |                | I <sub>OL</sub> = 8 mA  | 2.7 V                         |                 |                | 0.6                |     |      |  |
|                                |                | I <sub>OL</sub> = 12 mA   | 3 V                           |                 |                | 0.8                |     |      |  |
| I <sub>I</sub>                 | Control inputs | V <sub>I</sub> = 0 to 5.5 V                                     |                               | 3.6 V           |                |                    | ±5  | μΑ   |  |
| I <sub>off</sub>               |                | V <sub>I</sub> or V <sub>O</sub> = 5.5 V                        |                               | 0               |                |                    | ±10 | μΑ   |  |
| I <sub>OZ</sub> <sup>(2)</sup> |                | V <sub>O</sub> = 0 to 5.5 V                                     |                               | 3.6 V           |                |                    | ±10 | μΑ   |  |
|                                |                | V <sub>I</sub> = V <sub>CC</sub> or GND                         |                               | 2.6.1/          |                |                    | 10  | ^    |  |
| Icc                            |                | $3.6 \text{ V} \le \text{V}_{\text{I}} \le 5.5 \text{ V}^{(3)}$ | $I_O = 0$                     | 3.6 V           | 10             |                    |     | μА   |  |
| $\Delta I_{CC}$                |                | One input at V <sub>CC</sub> - 0.6 V, Other input               | uts at V <sub>CC</sub> or GND | 2.7 V to 3.6 V  |                |                    | 500 | μΑ   |  |
| C <sub>i</sub>                 | Control inputs | V <sub>I</sub> = V <sub>CC</sub> or GND                         |                               | 3.3 V           |                | 4                  |     | pF   |  |
| C <sub>io</sub>                | A or B ports   | V <sub>O</sub> = V <sub>CC</sub> or GND                         |                               | 3.3 V           |                | 5.5                |     | pF   |  |

## **Switching Characteristics**

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| PARAMETER          | FROM<br>(INPUT) | TO<br>(OUTPUT) |     | V <sub>CC</sub> = 1.8 V<br>± 0.15 V |     | 2.5 V<br>2 V | .5 V<br>V V <sub>CC</sub> = 2.7 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | UNIT |
|--------------------|-----------------|----------------|-----|-------------------------------------|-----|--------------|-----------------------------------|-----|------------------------------------|-----|------|
|                    | (INFOI)         | (001701)       | MIN | MAX                                 | MIN | MAX          | MIN                               | MAX | MIN                                | MAX |      |
| t <sub>pd</sub>    | A or B          | B or A         | (1) | (1)                                 | (1) | (1)          |                                   | 7.3 | 1.5                                | 6.3 | ns   |
| t <sub>en</sub>    | ŌĒ              | A or B         | (1) | (1)                                 | (1) | (1)          |                                   | 9.5 | 1.5                                | 8.2 | ns   |
| t <sub>dis</sub>   | ŌĒ              | A or B         | (1) | (1)                                 | (1) | (1)          |                                   | 8.5 | 1.7                                | 7.8 | ns   |
| t <sub>sk(o)</sub> |                 |                |     |                                     |     |              |                                   |     |                                    | 1   | ns   |

<sup>(1)</sup> This information was not available at the time of publication.

## **Operating Characteristics**

 $T_A = 25^{\circ}C$ 

|          | PARAMETER                     |                  |              | V <sub>CC</sub> = 1.8 V<br>TYP | V <sub>CC</sub> = 2.5 V<br>TYP | V <sub>CC</sub> = 3.3 V<br>TYP | UNIT |  |
|----------|-------------------------------|------------------|--------------|--------------------------------|--------------------------------|--------------------------------|------|--|
| C        | Power dissipation capacitance | Outputs enabled  | f = 10 MHz   | (1)                            | (1)                            | 48                             | 7    |  |
| $C_{pd}$ | per transceiver               | Outputs disabled | 1 = 10 10172 | (1)                            | (1)                            | 4                              | pF   |  |

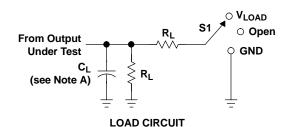
<sup>(1)</sup> This information was not available at the time of publication.

All typical values are at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C. For I/O ports, the parameter  $I_{OZ}$  includes the input leakage current.

<sup>(3)</sup> This applies in the disabled state only.

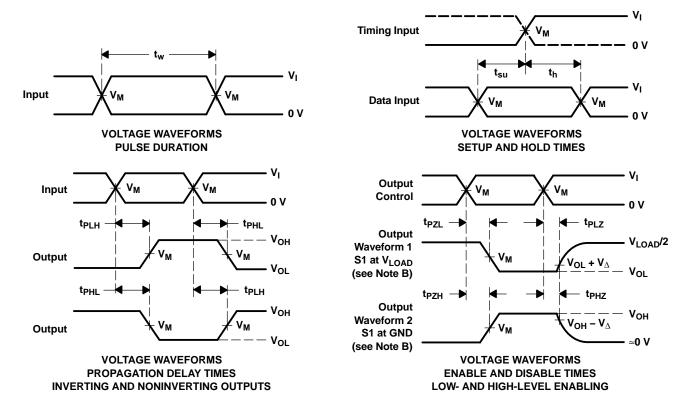


#### PARAMETER MEASUREMENT INFORMATION



| TEST                               | S1                |
|------------------------------------|-------------------|
| t <sub>PLH</sub> /t <sub>PHL</sub> | Open              |
| t <sub>PLZ</sub> /t <sub>PZL</sub> | V <sub>LOAD</sub> |
| t <sub>PHZ</sub> /t <sub>PZH</sub> | GND               |

| V                  | INF             | PUTS                           | .,                               | V                 | _     |                | V            |
|--------------------|-----------------|--------------------------------|----------------------------------|-------------------|-------|----------------|--------------|
| V <sub>CC</sub>    | VI              | t <sub>r</sub> /t <sub>f</sub> | V <sub>M</sub> V <sub>LOAD</sub> |                   | CL    | R <sub>L</sub> | $V_{\Delta}$ |
| 1.8 V $\pm$ 0.15 V | v <sub>cc</sub> | ≤2 ns                          | V <sub>CC</sub> /2               | 2×V <sub>CC</sub> | 30 pF | <b>1 k</b> Ω   | 0.15 V       |
| 2.5 V $\pm$ 0.2 V  | V <sub>CC</sub> | ≤2 ns                          | V <sub>CC</sub> /2               | 2×V <sub>CC</sub> | 30 pF | <b>500</b> Ω   | 0.15 V       |
| 2.7 V              | 2.7 V           | ≤2.5 ns                        | 1.5 V                            | 6 V               | 50 pF | 500 Ω          | 0.3 V        |
| 3.3 V $\pm$ 0.3 V  | 2.7 V           | ≤2.5 ns                        | 1.5 V                            | 6 V               | 50 pF | 500 Ω          | 0.3 V        |



- NOTES: A. C<sub>I</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_0$  = 50  $\Omega$ .
  - D. The outputs are measured one at a time, with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms







## **PACKAGING INFORMATION**

| Orderable Device   | Status (1) | Package<br>Type                  | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|--------------------|------------|----------------------------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| 74LVCR2245ADBQRE4  | ACTIVE     | SSOP/<br>QSOP                    | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1 YEAR          |
| 74LVCR2245ADBQRG4  | ACTIVE     | SSOP/<br>QSOP                    | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1 YEAR          |
| 74LVCR2245ADGVRE4  | ACTIVE     | TVSOP                            | DGV                | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74LVCR2245ADGVRG4  | ACTIVE     | TVSOP                            | DGV                | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74LVCR2245ARGYRG4  | ACTIVE     | QFN                              | RGY                | 20   | 1000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1 YEAR          |
| SN74LVCR2245ADBLE  | OBSOLETE   | SSOP                             | DB                 | 20   |                | TBD                       | Call TI          | Call TI                      |
| SN74LVCR2245ADBQR  | ACTIVE     | SSOP/<br>QSOP                    | DBQ                | 20   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1 YEAR          |
| SN74LVCR2245ADBR   | ACTIVE     | SSOP                             | DB                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245ADBRE4 | ACTIVE     | SSOP                             | DB                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245ADBRG4 | ACTIVE     | SSOP                             | DB                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245ADGVR  | ACTIVE     | TVSOP                            | DGV                | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245ADW    | ACTIVE     | SOIC                             | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245ADWE4  | ACTIVE     | SOIC                             | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245ADWG4  | ACTIVE     | SOIC                             | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245ADWR   | ACTIVE     | SOIC                             | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245ADWRE4 | ACTIVE     | SOIC                             | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245ADWRG4 | ACTIVE     | SOIC                             | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245AGQNR  | NRND       | BGA MI<br>CROSTA<br>R JUNI<br>OR | GQN                | 20   | 1000           | TBD                       | SNPB             | Level-1-240C-UNLIM           |
| SN74LVCR2245ANSR   | ACTIVE     | SO                               | NS                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245ANSRE4 | ACTIVE     | SO                               | NS                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245ANSRG4 | ACTIVE     | SO                               | NS                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245APW    | ACTIVE     | TSSOP                            | PW                 | 20   | 70             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245APWE4  | ACTIVE     | TSSOP                            | PW                 | 20   | 70             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245APWG4  | ACTIVE     | TSSOP                            | PW                 | 20   | 70             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245APWLE  | OBSOLETE   | TSSOP                            | PW                 | 20   |                | TBD                       | Call TI          | Call TI                      |



## PACKAGE OPTION ADDENDUM

4-Jun-2007

| Orderable Device   | Status <sup>(1)</sup> | Package<br>Type                  | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan <sup>(2)</sup>    | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|--------------------|-----------------------|----------------------------------|--------------------|------|----------------|----------------------------|------------------|------------------------------|
| SN74LVCR2245APWR   | ACTIVE                | TSSOP                            | PW                 | 20   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245APWRE4 | ACTIVE                | TSSOP                            | PW                 | 20   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245APWRG4 | ACTIVE                | TSSOP                            | PW                 | 20   | 2000           | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245APWT   | ACTIVE                | TSSOP                            | PW                 | 20   | 250            | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245APWTE4 | ACTIVE                | TSSOP                            | PW                 | 20   | 250            | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245APWTG4 | ACTIVE                | TSSOP                            | PW                 | 20   | 250            | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVCR2245ARGYR  | ACTIVE                | QFN                              | RGY                | 20   | 1000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-2-260C-1 YEAR          |
| SN74LVCR2245AZQNR  | ACTIVE                | BGA MI<br>CROSTA<br>R JUNI<br>OR | ZQN                | 20   | 1000           | Green (RoHS &<br>no Sb/Br) | SNAGCU           | Level-1-260C-UNLIM           |

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

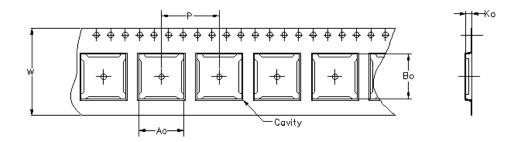
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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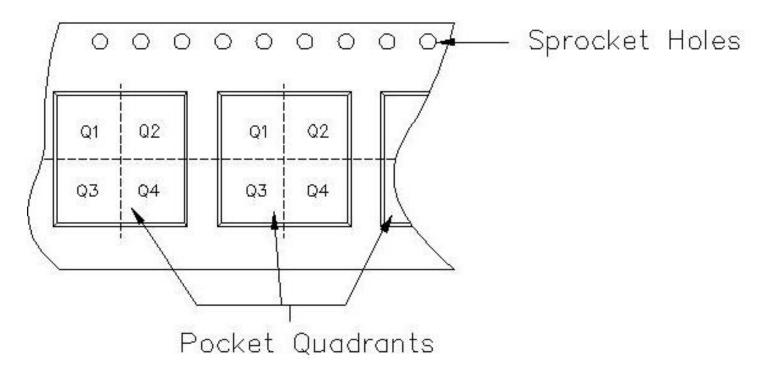
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Carrier tape design is defined largely by the component lentgh, width, and thickness.

| Ao =   | Dimension | designed | to | accommodate | the | component | width.     |
|--|-----------|----------|----|-------------|-----|-----------|------------|
| Bo =   | Dímension | designed | to | accommodate | the | component | length.    |
| Ko =   | Dímension | designed | to | accommodate | the | component | thickness. |
| W = Overall width of the carrier tape.       |           |          |    |             |     |           |            |
| P = Pitch between successive cavity centers. |           |          |    |             |     |           |            |

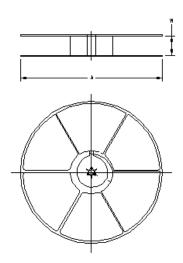


## TAPE AND REEL INFORMATION



19-May-2007

| Device            | Package | Pins | Site | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>(mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------------|---------|------|------|--------------------------|-----------------------|---------|---------|---------|------------|-----------|------------------|
| SN74LVCR2245ADBQR | DBQ     | 20   | MLA  | 330                      | 16                    | 6.5     | 9.0     | 2.1     | 8          | 16        | Q1               |
| SN74LVCR2245ADBR  | DB      | 20   | MLA  | 330                      | 16                    | 8.2     | 7.5     | 2.5     | 12         | 16        | Q1               |
| SN74LVCR2245ADGVR | DGV     | 20   | MLA  | 330                      | 12                    | 7.0     | 5.6     | 1.6     | 8          | 12        | Q1               |
| SN74LVCR2245ADWR  | DW      | 20   | MLA  | 330                      | 24                    | 10.8    | 13.0    | 2.7     | 12         | 24        | Q1               |
| SN74LVCR2245AGQNR | GQN     | 20   | HIJ  | 330                      | 12                    | 3.3     | 4.3     | 1.5     | 8          | 12        | Q1               |
| SN74LVCR2245ANSR  | NS      | 20   | MLA  | 330                      | 24                    | 8.2     | 13.0    | 2.5     | 12         | 24        | Q1               |
| SN74LVCR2245APWR  | PW      | 20   | MLA  | 330                      | 16                    | 6.95    | 7.1     | 1.6     | 8          | 16        | Q1               |
| SN74LVCR2245ARGYR | RGY     | 20   | MLA  | 180                      | 12                    | 3.8     | 4.8     | 1.6     | 8          | 12        | Q1               |
| SN74LVCR2245AZQNR | ZQN     | 20   | HIJ  | 330                      | 12                    | 3.3     | 4.3     | 1.5     | 8          | 12        | Q1               |



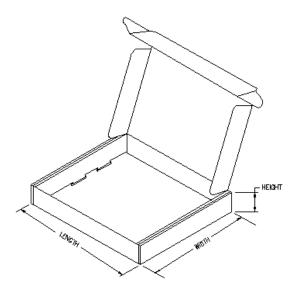
## TAPE AND REEL BOX INFORMATION

| Device            | Package | Pins | Site | Length (mm) | Width (mm) | Height (mm) |
|-------------------|---------|------|------|-------------|------------|-------------|
| SN74LVCR2245ADBQR | DBQ     | 20   | MLA  | 0.0         | 0.0        | 0.0         |
| SN74LVCR2245ADBR  | DB      | 20   | MLA  | 342.9       | 336.6      | 28.58       |
| SN74LVCR2245ADGVR | DGV     | 20   | MLA  | 338.1       | 340.5      | 20.64       |
| SN74LVCR2245ADWR  | DW      | 20   | MLA  | 333.2       | 333.2      | 31.75       |
| SN74LVCR2245AGQNR | GQN     | 20   | HIJ  | 346.0       | 346.0      | 29.0        |
| SN74LVCR2245ANSR  | NS      | 20   | MLA  | 333.2       | 333.2      | 31.75       |
| SN74LVCR2245APWR  | PW      | 20   | MLA  | 342.9       | 336.6      | 28.58       |
| SN74LVCR2245ARGYR | RGY     | 20   | MLA  | 190.0       | 212.7      | 31.75       |
| SN74LVCR2245AZQNR | ZQN     | 20   | HIJ  | 346.0       | 346.0      | 29.0        |



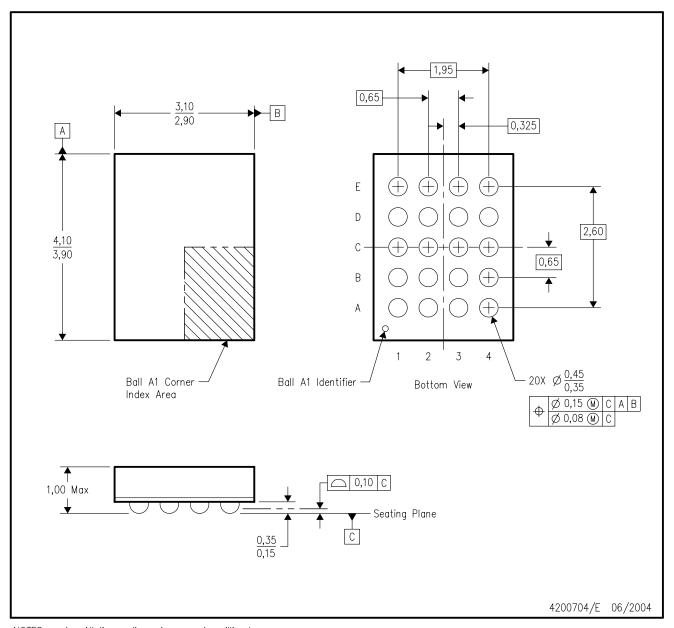


19-May-2007



# GQN (R-PBGA-N20)

## PLASTIC BALL GRID ARRAY



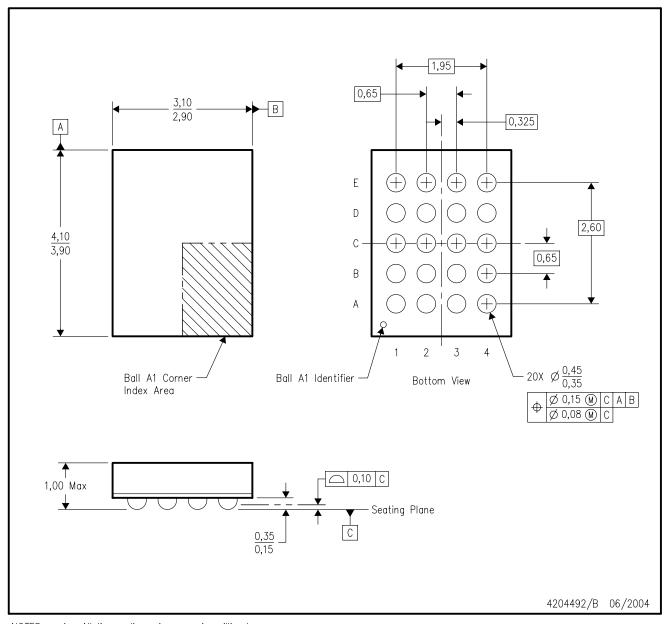
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-225 variation BC.
- D. This package is tin-lead (SnPb). Refer to the 20 ZQN package (drawing 4204492) for lead-free.



# ZQN (R-PBGA-N20)

## PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-225 variation BC.
- D. This package is lead-free. Refer to the 20 GQN package (drawing 4200704) for tin-lead (SnPb).



## DGV (R-PDSO-G\*\*)

## 24 PINS SHOWN

#### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

# DW (R-PDSO-G20)

## PLASTIC SMALL-OUTLINE PACKAGE



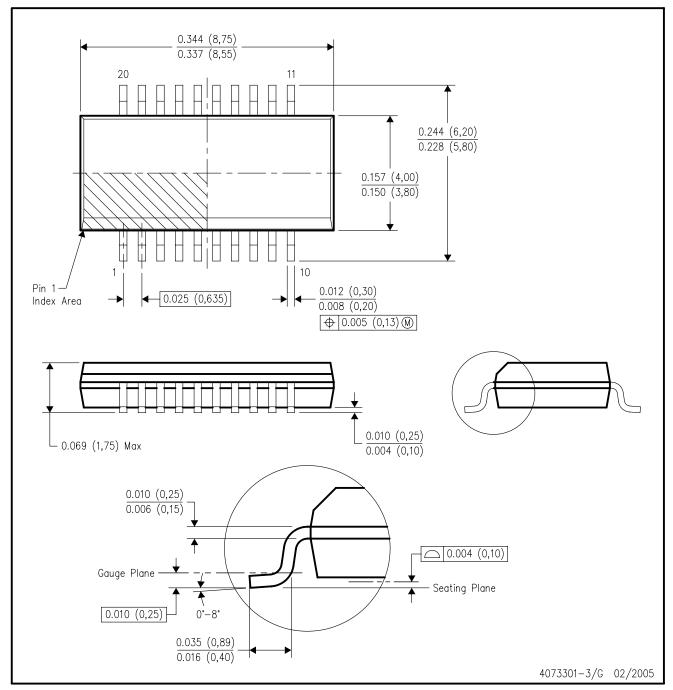
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



# DBQ (R-PDSO-G20)

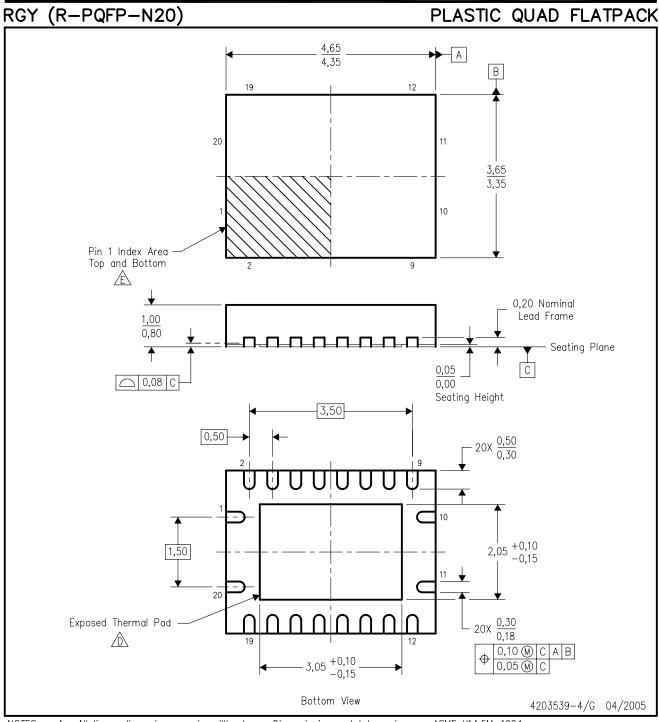
## PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15) per side.
- D. Falls within JEDEC MO-137 variation AD.





NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. QFN (Quad Flatpack No-Lead) package configuration.
- The package thermal pad must be soldered to the board for thermal and mechanical performance.
- Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.
- F. Package complies to JEDEC MO-241 variation BC.



## **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

## PW (R-PDSO-G\*\*)

### 14 PINS SHOWN

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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